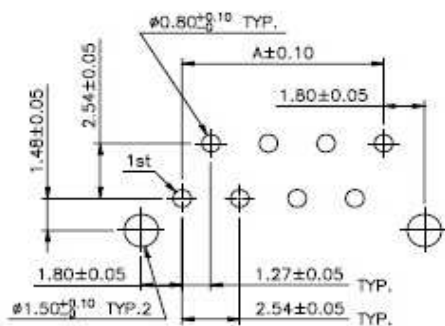
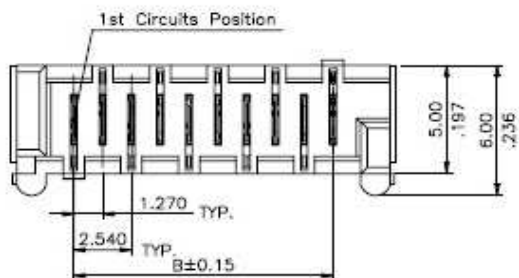
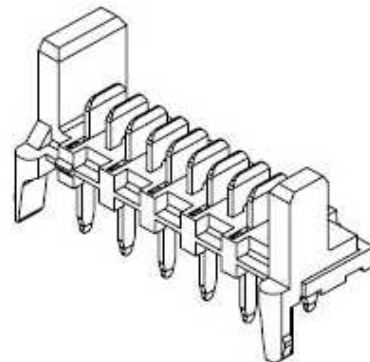
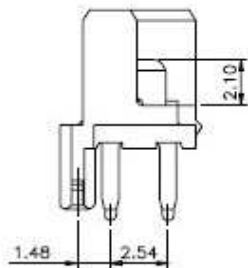
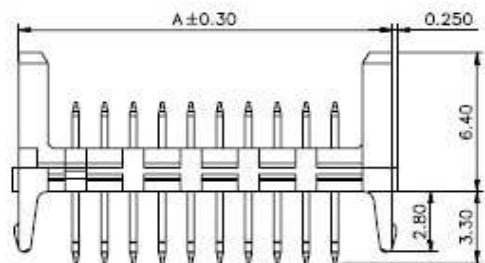


ROHS



Recommended P.C. Board Layout

■ Specifications(规格) :

- Voltage rating(额定电压): 500V AC / DC
- Current rating(额定电流): 1.0A AC / DC
- Withstanding voltage(耐压值): 500V AC/minute
- Temperature range(工作温度): -40° C~+105° C
- Insulation resistance(绝缘电阻): ≥1000MΩ
- Contact resistance(接触电阻): ≤15mΩ

■ Wafer(针座)

- Poles (PIN数) :04-26P
- Material (材质) :Nylon 10T+30% G.F UL 94V-0
Pin针: Brass (黄铜)
Finish (电镀) :Tin-Plated (镀锡)

Circuit	Dimension	
	A	B
04	8.89	3.81
06	11.40	6.35
08	13.94	8.89
10	16.48	11.43
12	19.02	13.97
14	21.56	16.51
16	24.10	19.05
18	26.64	21.59
20	29.18	24.13
22	31.72	26.67
24	34.26	29.21
26	36.77	31.72

03						一般公差 GENERAL TOLERANCE	料号 Part NO:	GOSUN™			
02				绘图 DRA		.X ±0.3 .XX ±0.2 .XXX ±0.1	FDC4S- XX P				
2010/08/25	A	B		审核 CHK		角法 PROJECT	品名 TITLE:	核准 APPD	审核 CHK	绘图 DRA	日期 DATA
日期 DATA	旧版次 OLD REV	新版次 NEW REV	变更内容 DESCRIPTION	核准 APPD		⊕	1.27mm IDT Type Wafer 180°	Eis	Clam	Wang	2010/08/25
						⊕	单位 UNIT MM	比例 SCALE 1/1	覆片 NUMREP A-001	版次 REV ▲	